CY7C1019CV33

## $128 \mathrm{~K} \times 8$ Static RAM

## Features

- Pin and function compatible with CY7C1019BV33
- High speed
$-\mathrm{t}_{\mathrm{AA}}=8,10,12,15 \mathrm{~ns}$
- CMOS for optimum speed/power
- Data retention at 2.0V
- Center power/ground pinout
- Automatic power-down when deselected
- Easy memory expansion with CE and OE options
- Available in 48-ball VFBGA, 32-pin TSOP II and 400-mil SOJ package
- Also available in lead-free 48-ball VFBGA and 32-pin TSOP II packages


## Functional Description

The CY7C1019CV33 is a high-performance CMOS static RAM organized as 131,072 words by 8 bits. Easy memory
expansion is provided by an active LOW Chip Enable ( $\overline{\mathrm{CE}})$, an active LOW Output Enable ( $\overline{\mathrm{OE}})$, and three-state drivers. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

Writing to the device is accomplished by taking Chip Enable ( $\overline{\mathrm{CE}}$ ) and Write Enable ( $\overline{\mathrm{WE}}$ ) inputs LOW. Data on the eight I/O pins $\left(1 / O_{0}\right.$ through $\left.I / O_{7}\right)$ is then written into the location specified on the address pins ( $\mathrm{A}_{0}$ through $\mathrm{A}_{16}$ ).
Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins $\left(1 / O_{0}\right.$ through $\left.I / O_{7}\right)$ are placed in a high-impedance state when the device is deselected ( $\overline{\mathrm{CE}}$ HIGH), the outputs are disabled (OE HIGH), or during a write operation ( $\overline{\mathrm{CE}}$ LOW, and WE LOW).

The CY7C1019CV33 is available in Standard 48-ball FBGA, 32-pin TSOP II and 400-mil-wide SOJ packages.


## Pin Configuration

SOJ/TSOP II Top View

| $\mathrm{A}_{0}$ | 1 | 32 | $\mathrm{A}_{16}$ |
| :---: | :---: | :---: | :---: |
| $\mathrm{A}_{1}$ | 2 | 31 | $\mathrm{A}_{15}$ |
| $\mathrm{A}_{2}$ | 3 | 30 | $\mathrm{A}_{14}$ |
| $\mathrm{A}_{3}$ | 4 | 29 | $\mathrm{A}_{13}$ |
| $\overline{\mathrm{CE}}$ | 5 | 28 | OE |
| I/O $\mathrm{O}_{0}$ | 6 | 27 | $1 / \mathrm{O}_{7}$ |
| I/O $\mathrm{O}_{1}$ | 7 | 26 | $1 / O_{6}$ |
| $V_{C C}$ | 8 | 25 | $\mathrm{V}_{\mathrm{SS}}$ |
| $\mathrm{V}_{\text {SS }}$ | 9 | 24 | $\mathrm{V}_{\mathrm{CC}}$ |
| I/O2 | 10 | 23 | $1 / \mathrm{O}_{5}$ |
| I/O3 | 11 | 22 | $\square 1 / \mathrm{O}_{4}$ |
| WE | 12 | 21 | $\mathrm{A}_{12}$ |
| $\mathrm{A}_{4}$ | 13 | 20 | $\mathrm{A}_{11}$ |
| $\mathrm{A}_{5}$ | 14 | 19 | $\mathrm{A}_{10}$ |
| $\mathrm{A}_{6}$ | 15 | 18 | $A_{9}$ |
|  | 16 | 17 | $\mathrm{A}_{8}$ |

Pin Configuration (continued)


## Selection Guide

|  | 7C1019CV33-8 | 7C1019CV33-10 | 7C1019CV33-12 | 7C1019CV33-15 | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Maximum Access Time | 8 | 10 | 12 | 15 | ns |
| Maximum Operating Current | 85 | 80 | 75 | 70 | mA |
| Maximum Standby Current | 5 | 5 | 5 | 5 | mA |

CY7C1019CV33

## Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)
Storage Temperature $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Ambient Temperature with
Power Applied $\qquad$ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Supply Voltage on $\mathrm{V}_{\mathrm{CC}}$ to Relative $\mathrm{GND}^{[1]} \ldots-0.5 \mathrm{~V}$ to +4.6 V
DC Voltage Applied to Outputs
in High-Z State ${ }^{[1]}$. $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{Cc}}+0.5 \mathrm{~V}$
DC Input Voltage ${ }^{[1]}$
-0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$

Current into Outputs (LOW)........................................ 20 mA
Static Discharge Voltage............................................ >2001V
(per MIL-STD-883, Method 3015)
Latch-up Current..................................................... >200 mA

## Operating Range

| Range | Ambient <br> Temperature | $\mathbf{V}_{\text {cc }}$ |
| :--- | :---: | :---: |
| Commercial | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $3.3 \mathrm{~V} \pm 10 \%$ |
| Industrial | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $3.3 \mathrm{~V} \pm 10 \%$ |

Electrical Characteristics Over the Operating Range

| Parameter | Description | Test Conditions | $\begin{gathered} \text { 7C1019CV33 } \\ -8 \end{gathered}$ |  | $\begin{gathered} \text { 7C1019CV33 } \\ -10 \end{gathered}$ |  | $\begin{gathered} \text { 7C1019CV33 } \\ -12 \end{gathered}$ |  | $\begin{gathered} \text { 7C1019CV33 } \\ -15 \end{gathered}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\text { Min. }, \\ & \mathrm{I}_{\mathrm{OH}}=-4.0 \mathrm{~mA} \end{aligned}$ | 2.4 |  | 2.4 |  | 2.4 |  | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{Min} ., \\ & \mathrm{l}_{\mathrm{LL}}=8.0 \mathrm{~mA} \end{aligned}$ |  | 0.4 |  | 0.4 |  | 0.4 |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage |  | 2.0 | $\mathrm{V}_{\mathrm{Cc}}+0.3$ | 2.0 | $\mathrm{V}_{\mathrm{CC}}+0.3$ | 2.0 | $\mathrm{V}_{\mathrm{Cc}}+0.3$ | 2.0 | $\mathrm{V}_{\mathrm{Cc}}+0.3$ | V |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage ${ }^{[1]}$ |  | -0.3 | 0.8 | -0.3 | 0.8 | -0.3 | 0.8 | -0.3 | 0.8 | V |
| $\mathrm{I}_{\mathrm{IX}}$ | Input Load Current | $\mathrm{GND} \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{CC}}$ | -1 | +1 | -1 | +1 | -1 | +1 | -1 | +1 | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\mathrm{Oz}}$ | Output Leakage Current | $\mathrm{GND} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}}$, Output Disabled | -1 | +1 | -1 | +1 | -1 | +1 | -1 | +1 | $\mu \mathrm{A}$ |
| $\mathrm{IOS}^{[2 .]}$ | Output Short Circuit Current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{Max.,} \\ & \mathrm{~V}_{\mathrm{OUT}}=\mathrm{GND} \end{aligned}$ |  | -300 |  | -300 |  | -300 |  | -300 | mA |
| ${ }^{\text {ICC }}$ | $\mathrm{V}_{\mathrm{CC}}$ Operating Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{Max} ., \\ & \mathrm{l}_{\mathrm{OUT}}=0 \mathrm{~mA}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}}=1 / \mathrm{t}_{\mathrm{RC}} \end{aligned}$ |  | 85 |  | 80 |  | 75 |  | 70 | mA |
| $\mathrm{I}_{\text {SB1 }}$ | Automatic CE <br> Power-down Current -TTL Inputs | $\left\lvert\, \begin{aligned} & \text { Max. } V_{\mathrm{CC}}, \overline{\mathrm{CE}} \geq \\ & \mathrm{V}_{\text {IH }} \\ & \mathrm{V}_{\text {IN }} \geq \mathrm{V}_{\text {IH }} \text { or } \\ & \mathrm{V}_{\text {IN }} \leq \mathrm{V}_{\text {IL }}, f=\mathrm{f}_{\mathrm{MAX}} \end{aligned}\right.$ |  | 15 |  | 15 |  | 15 |  | 15 | mA |
| $\mathrm{I}_{\text {SB2 }}$ | Automatic CE <br> Power-down Current -CMOS Inputs | $\begin{array}{\|l} \text { Max. } V_{C C}, \\ C E \\ V_{C C}-0.3 V \\ V_{\text {IN }} \geq V_{C C}-0.3 V \\ \text { or } V_{\text {IN }} \leq 0.3 V, f=0 \end{array}$ |  | 5 |  | 5 |  | 5 |  | 5 | mA |

## Capacitance ${ }^{[3]}$

| Parameter | Description | Test Conditions | Max. | Unit |
| :--- | :--- | :--- | :--- | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}$, | 8 | pF |
| $\mathrm{C}_{\mathrm{OUT}}$ | Output Capacitance | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ | 8 | pF |
|  |  | 8 | 8 |  |

## Notes:

1. $\mathrm{V}_{\mathrm{IL}}$ (min.) $=-2.0 \mathrm{~V}$ for pulse durations of less than 20 ns .
2. Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.
3. Tested initially and after any design or process changes that may affect these parameters.

## AC Test Loads and Waveforms ${ }^{[4]}$


(a)


ALL INPUT PULSES
(c)
Fall Time: $1 \mathrm{~V} / \mathrm{ns}$
10-, 12-, 15-ns devices:
(b)

High-Z characteristics:

(d)

Switching Characteristics ${ }^{[5]}$ Over the Operating Range


| $\mathrm{t}_{\mathrm{RC}}$ | Read Cycle Time | 8 |  | 10 |  | 12 |  | 15 |  | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{AA}}$ | Address to Data Valid |  | 8 |  | 10 |  | 12 |  | 15 | ns |
| $\mathrm{t}_{\text {OHA }}$ | Data Hold from Address Change | 3 |  | 3 |  | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {ACE }}$ | $\overline{\mathrm{CE}}$ LOW to Data Valid |  | 8 |  | 10 |  | 12 |  | 15 | ns |
| $\mathrm{t}_{\text {DOE }}$ | $\overline{\mathrm{OE}}$ LOW to Data Valid |  | 5 |  | 5 |  | 6 |  | 7 | ns |
| $\mathrm{t}_{\text {LZOE }}$ | $\overline{\mathrm{OE}}$ LOW to Low Z | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {HZOE }}$ | $\overline{\text { OE }}$ HIGH to High $\mathrm{Z}^{[6,7]}$ |  | 4 |  | 5 |  | 6 |  | 7 | ns |
| tızCE | $\overline{\mathrm{CE}}$ LOW to Low $\mathrm{Z}^{[7]}$ | 3 |  | 3 |  | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {HZCE }}$ | $\overline{\overline{C E}}$ HIGH to High ${ }^{[6,7]}$ |  | 4 |  | 5 |  | 6 |  | 7 | ns |
| $\mathrm{t}_{\mathrm{Pu}}{ }^{[8]}$ | $\overline{\mathrm{CE}}$ LOW to Power-Up | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PD }}{ }^{\text {[8] }}$ | $\overline{\mathrm{CE}}$ HIGH to Power-Down |  | 8 |  | 10 |  | 12 |  | 15 | ns |

Write Cycle ${ }^{[9,10]}$

| $\mathrm{t}_{\text {WC }}$ | Write Cycle Time | 8 |  | 10 |  | 12 |  | 15 |  | ns |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {SCE }}$ | $\overline{\text { CE LOW to Write End }}$ | 7 |  | 8 |  | 9 |  | 10 |  | ns |
| $\mathrm{t}_{\text {AW }}$ | Address Set-Up to Write End | 7 |  | 8 |  | 9 |  | 10 |  | ns |
| $\mathrm{t}_{\mathrm{HA}}$ | Address Hold from Write End | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {SA }}$ | Address Set-Up to Write Start | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PWE }}$ | $\overline{\text { WE Pulse Width }}$ | 6 |  | 7 |  | 8 |  | 10 |  | ns |
| $\mathrm{t}_{\text {SD }}$ | Data Set-Up to Write End | 5 |  | 5 |  | 6 |  | 8 |  | ns |
| $\mathrm{t}_{\text {HD }}$ | Data Hold from Write End | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {LZWE }}$ | $\overline{\text { WE HIGH to Low Z }}{ }^{[7]}$ | 3 |  | 3 |  | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {HZWE }}$ | $\overline{\text { WE LOW to High Z }}{ }^{[6,7]}$ |  | 4 |  | 5 |  | 6 |  | 7 | ns |

## Notes:

4. AC characteristics (except High-Z) for all 8-ns parts are tested using the load conditions shown in Figure (a). All other speeds are tested using the Thevenin load shown in Figure (b). High-Z characteristics are tested for all speeds using the test load shown in Figure (d).
5. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V , input pulse levels of 0 to 3.0 V .
6. $t_{\text {HZOE }}, t_{\text {HZCE }}$, and $t_{\text {HZWE }}$ are specified with a load capacitance of 5 pF as in part (d) of AC Test Loads. Transition is measured $\pm 500 \mathrm{mV}$ from steady-state voltage.
7. At any given temperature and voltage condition, $t_{H Z C E}$ is less than $t_{L Z C E}, t_{H Z O E}$ is less than $t_{\text {LZOE }}$, and $t_{H Z W E}$ is less than $t_{L Z W E}$ for any given device.
8. This parameter is guaranteed by design and is not tested.
9. The internal write time of the memory is defined by the overlap of $\overline{C E}$ LOW and $\overline{W E}$ LOW. $\overline{C E}$ and $\overline{W E}$ must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.
10. The minimum write cycle time for Write Cycle no. 3 ( $\overline{\mathrm{WE}}$ controlled, $\overline{\mathrm{OE}} \mathrm{LOW}$ ) is the sum of $\mathrm{t}_{\mathrm{HZWE}}$ and $\mathrm{t}_{\mathrm{SD}}$.

## Switching Waveforms

Read Cycle No. $\mathbf{1}^{[11,12]}$


Read Cycle No. 2 ( $\overline{\mathrm{OE}}$ Controlled) ${ }^{[12,13]}$


Write Cycle No. 1 ( $\overline{\text { CE Controlled }}{ }^{[14,15]}$


## Notes:

11. Device is continuously selected. $\overline{\mathrm{OE}}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}$.
12. WE is HIGH for read cycle.
13. Address valid prior to or coincident with $\overline{\mathrm{CE}}$ transition LOW
14. Data $I / O$ is high impedance if $O E=V_{I H}$.
15. If $\overline{\mathrm{CE}}$ goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.

## Switching Waveforms (continued)

Write Cycle No. 2 (WE Controlled, $\overline{\mathrm{OE}}$ HIGH During Write) ${ }^{[14,15]}$


Write Cycle No. 3 ( $\overline{\mathrm{WE}}$ Controlled, $\overline{\mathrm{OE}}$ LOW) ${ }^{[15]}$


Truth Table

| $\overline{C E}$ | $\overline{\mathrm{OE}}$ | WE | $1 / \mathrm{O}_{0}-1 / \mathrm{O}_{7}$ | Mode | Power |
| :---: | :---: | :---: | :---: | :---: | :---: |
| H | X | X | High Z | Power-Down | Standby ( $\mathrm{I}_{\text {SB }}$ ) |
| L | L | H | Data Out | Read | Active ( $\mathrm{I}_{\text {CC }}$ ) |
| L | X | L | Data In | Write | Active ( $\mathrm{I}_{\text {cc }}$ ) |
| L | H | H | High Z | Selected, Outputs Disabled | Active (ICc) |

16. During this period the I/Os are in the output state and input signals should not be applied.

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Ordering Information

| Speed (ns) | Ordering Code | Package Diagram | Package Type | Operating Range |
| :---: | :---: | :---: | :---: | :---: |
| 8 | CY7C1019CV33-8VC | 51-85033 | 32-pin 400-Mil Molded SOJ | Commercial |
|  | CY7C1019CV33-8VI | 51-85033 | 32-pin 400-Mil Molded SOJ | Industrial |
| 10 | CY7C1019CV33-10VC | 51-85033 | 32-pin 400-Mil Molded SOJ | Commercial |
|  | CY7C1019CV33-10ZC | 51-85095 | 32-pin TSOP II |  |
|  | CY7C1019CV33-10ZXC | 51-85095 | 32-pin TSOP II (Pb-Free) |  |
|  | CY7C1019CV33-10VI | 51-85033 | 32-pin 400-Mil Molded SOJ | Industrial |
|  | CY7C1019CV33-10ZI | 51-85095 | 32-pin TSOP II |  |
|  | CY7C1019CV33-10ZXI | 51-85095 | 32-pin TSOP II (Pb-Free) |  |
| 12 | CY7C1019CV33-12VC | 51-85033 | 32-pin 400-Mil Molded SOJ | Commercial |
|  | CY7C1019CV33-12ZC | 51-85095 | 32-pin TSOP II |  |
|  | CY7C1019CV33-12ZXC | 51-85095 | 32-pin TSOP II (Pb-Free) |  |
|  | CY7C1019CV33-12VI | 51-85033 | 32-pin 400-Mil Molded SOJ | Industrial |
|  | CY7C1019CV33-12ZI | 51-85095 | 32-pin TSOP II |  |
|  | CY7C1019CV33-12BVI | 51-85150 | 48-ball VFBGA |  |
|  | CY7C1019CV33-12BVXI | 51-85150 | 48-ball VFBGA (Pb-Free) |  |
| 15 | CY7C1019CV33-15VC | 51-85033 | 32-pin 400-Mil Molded SOJ | Commercial |
|  | CY7C1019CV33-15ZC | 51-85095 | 32-pin TSOP II |  |
|  | CY7C1019CV33-15ZXC | 51-85095 | 32-pin TSOP II (Pb-Free) |  |
|  | CY7C1019CV33-15VI | 51-85033 | 32-pin 400-Mil Molded SOJ | Industrial |
|  | CY7C1019CV33-15ZI | 51-85095 | 32-pin TSOP II |  |
|  | CY7C1019CV33-15ZXI | 51-85095 | 32-pin TSOP II (Pb-Free) |  |

## Package Diagrams

32-pin (400-Mil) Molded SOJ (51-85033)


DIMENSIDNS IN INCHES $\frac{M_{1} N_{2}}{M A X}$


Package Diagrams (continued)


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## Package Diagrams (continued)

## 48-ball VFBGA (6 x $8 \times 1 \mathrm{~mm}$ ) (51-85150)



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Document History Page

| Document Title: CY7C1019CV33 128K x 8 Static RAM Document Number: 38-05130 |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| REV. | ECN NO. | $\begin{aligned} & \text { Issue } \\ & \text { Date } \end{aligned}$ | Orig. of Change | Description of Change |
| ** | 109245 | 12/16/01 | HGK | New Data Sheet |
| *A | 113431 | 04/10/02 | NSL | AC Test Loads split based on speed. |
| *B | 115047 | 08/01/02 | HGK | Added TSOP II Package and I Temp. Improved I ${ }_{\text {CC }}$ limits. |
| *C | 119796 | 10/11/02 | DFP | Updated standby current from 5 nA to 5 mA . |
| *D | 123030 | 12/17/02 | DFP | Updated Truth Table to reflect single Chip Enable option. |
| *E | 419983 | See ECN | NXR | Added 48-ball VFBGA Package <br> Added lead-free parts in Ordering Information Table <br> Replaced Package Name column with Package Diagram in the Ordering Information table. |

